

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

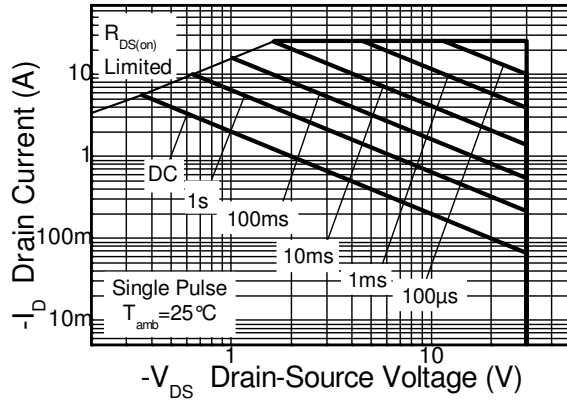
Characteristic		Symbol	Value	Unit	
Drain-Source Voltage		V _{DSS}	-30	V	
Gate-Source Voltage		V _{GS}	±20	V	
Continuous Drain Current	V _{GS} = 10V	I _D	(Note 6)	-7.5	A
			T _A = +70°C (Note 6)	-6.0	
			(Note 5)	-5.4	
Pulsed Drain Current	V _{GS} = 10V	I _{DM}	-24.9	A	
Continuous Source Current (Body diode)		I _S	-3.2	A	
Pulsed Source Current (Body diode)		I _{SM}	-24.9	A	

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

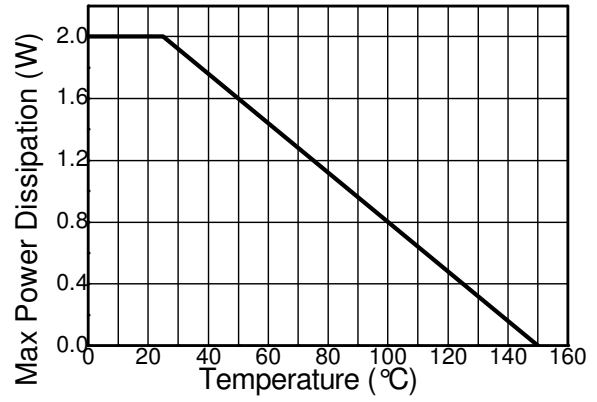
Characteristic		Symbol	Value	Unit
Power Dissipation	(Note 5)	P _D	2.0	W
	Linear Derating Factor		16	
Linear Derating Factor	(Note 6)		3.9	mW/°C
			31	
Thermal Resistance, Junction to Ambient	(Note 5)	R _{θJA}	62.5	°C/W
	(Note 6)		32.2	
Thermal Resistance, Junction to Lead	(Note 8)	R _{θJL}	8.51	
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to 150	°C

- Notes:
5. For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
 6. Same as Note (5), except the device is measured at t ≤ 10 sec.
 7. Same as Note (5), except the device is pulsed with D= 0.02 and pulse width 300 μs. The pulse current is limited by the maximum junction temperature.
 8. Thermal resistance from junction to solder-point (at the end of the drain lead).

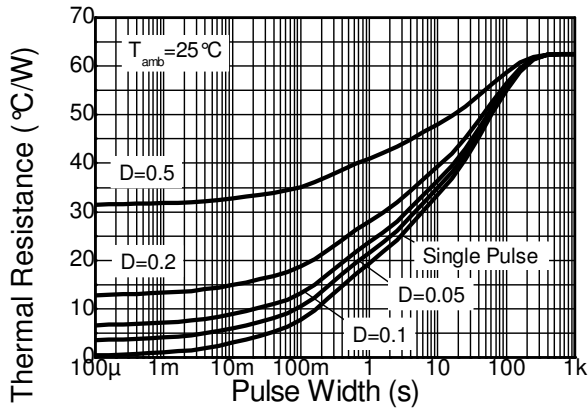
Thermal Characteristics



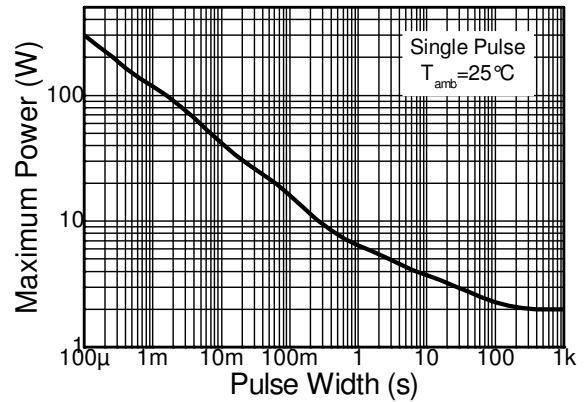
Safe Operating Area



Derating Curve



Transient Thermal Impedance



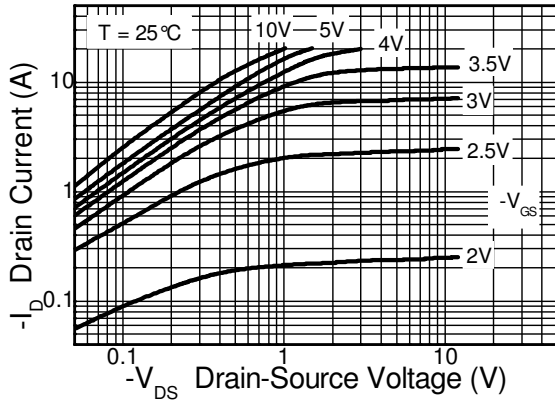
Pulse Power Dissipation

Electrical Characteristics (@T_A = +25 °C, unless otherwise specified.)

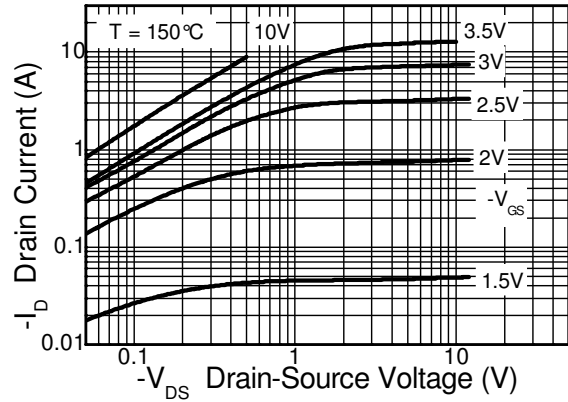
Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV _{DSS}	-30	—	—	V	I _D = -250μA, V _{GS} = 0V
Zero Gate Voltage Drain Current	I _{DSS}	—	—	-1	μA	V _{DS} = -30V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	—	—	±100	nA	V _{GS} = ±20V, V _{DS} = 0V
ON CHARACTERISTICS						
Gate Threshold Voltage	V _{GS(th)}	-1.0	—	—	V	I _D = -250μA, V _{DS} = V _{GS}
Static Drain-Source On-Resistance (Note 9)	R _{DS(on)}	—	—	45	mΩ	V _{GS} = -10V, I _D = -4.2A
				70		V _{GS} = -4.5V, I _D = -3.4A
Forward Transconductance (Notes 9 & 10)	g _{fs}	—	9.2	—	S	V _{DS} = -15V, I _D = -4.2A
Diode Forward Voltage (Note 9)	V _{SD}	—	-0.85	-0.95	V	I _S = -3.6A, V _{GS} = 0V, T _J = +25 °C
Reverse Recovery Time (Note 10)	t _{rr}	—	21.7	—	ns	I _F = -2A, di/dt = 100A/μs, T _J = +25 °C
Reverse Recovery Charge (Note 10)	Q _{rr}	—	16.1	—	nC	T _J = +25 °C
DYNAMIC CHARACTERISTICS (Note 10)						
Input Capacitance	C _{iSS}	—	1,022	—	pF	V _{DS} = -15V, V _{GS} = 0V f = 1MHz
Output Capacitance	C _{oss}	—	267	—	pF	
Reverse Transfer Capacitance	C _{rSS}	—	229	—	pF	
Total Gate Charge (Note 11)	Q _g	—	17.2	—	nC	V _{GS} = -5V
Total Gate Charge (Note 11)	Q _g	—	29.6	—	nC	V _{GS} = -10V V _{DS} = -15V I _D = -4.2A
Gate-Source Charge (Note 11)	Q _{gs}	—	2.8	—	nC	
Gate-Drain Charge (Note 11)	Q _{gd}	—	8.6	—	nC	
Turn-On Delay Time (Note 11)	t _{D(on)}	—	3.8	—	ns	V _{DD} = -15V, V _{GS} = -10V I _D = -1A, R _G ≅ 6.0Ω
Turn-On Rise Time (Note 11)	t _r	—	6.5	—	ns	
Turn-Off Delay Time (Note 11)	t _{D(off)}	—	37.1	—	ns	
Turn-Off Fall Time (Note 11)	t _f	—	21.4	—	ns	

Notes: 9. Measured under pulsed conditions. Pulse width ≤ 300μs; duty cycle ≤ 2%.
 10. For design aid only, not subject to production testing.
 11. Switching characteristics are independent of operating junction temperatures.

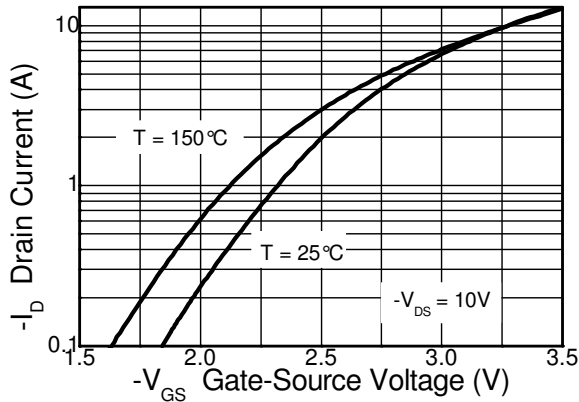
Typical Characteristics



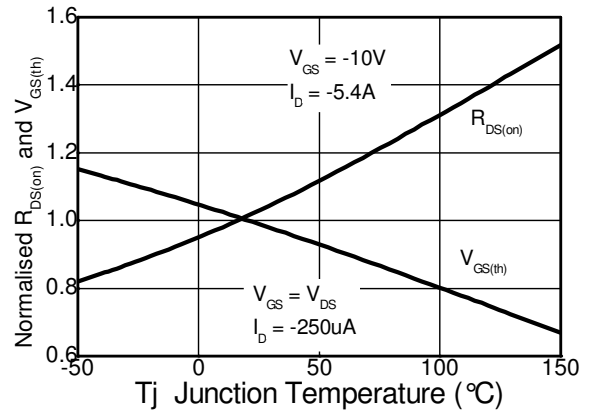
Output Characteristics



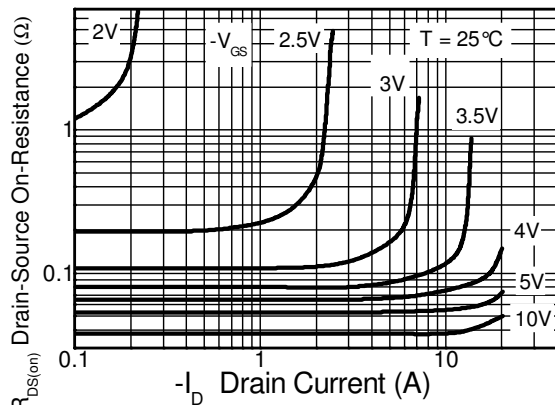
Output Characteristics



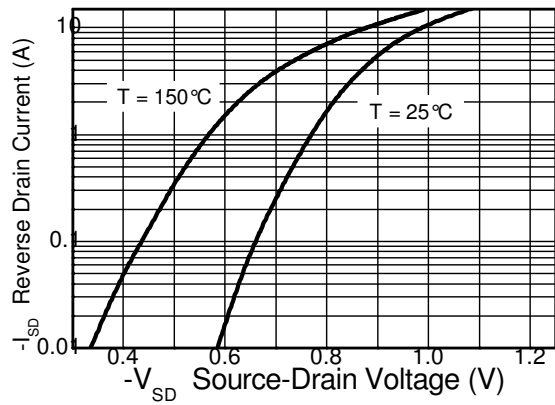
Typical Transfer Characteristics



Normalised Curves v Temperature

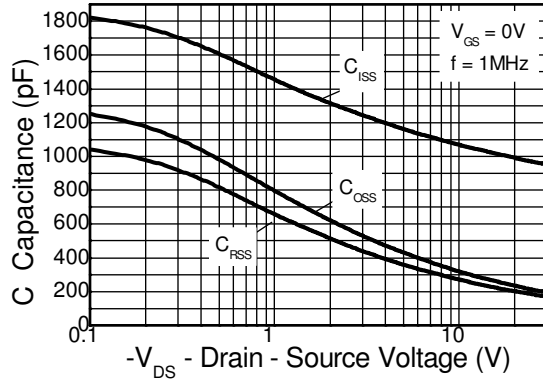


On-Resistance v Drain Current

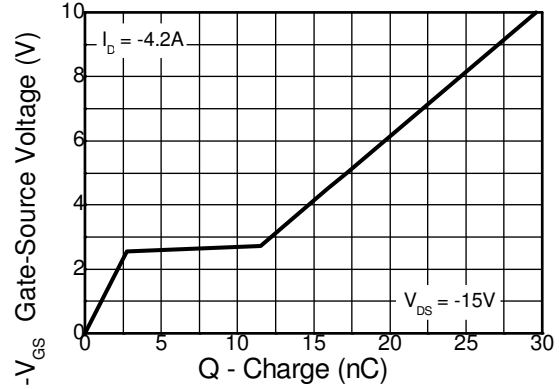


Source-Drain Diode Forward Voltage

Typical Characteristics (continued)

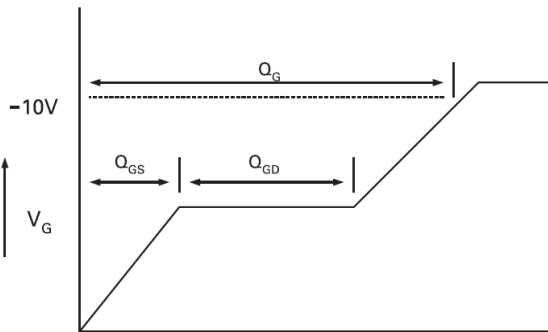


Capacitance v Drain-Source Voltage

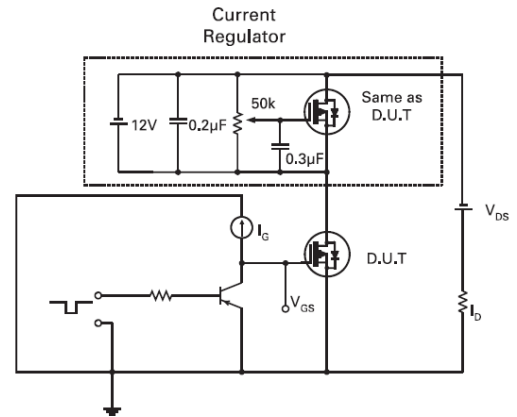


Gate-Source Voltage v Gate Charge

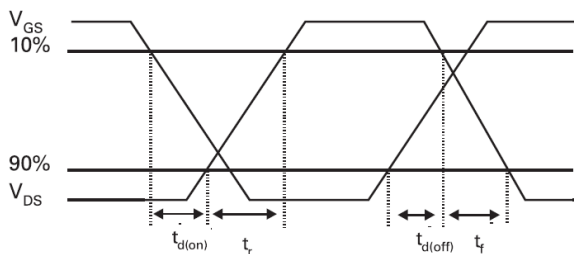
Test Circuits



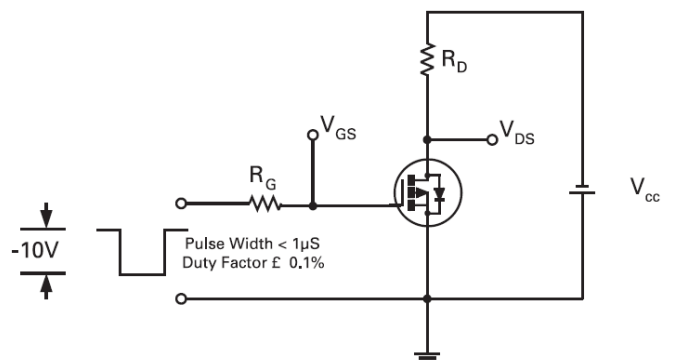
Basic Gate Charge Waveform



Gate Charge Test Circuit



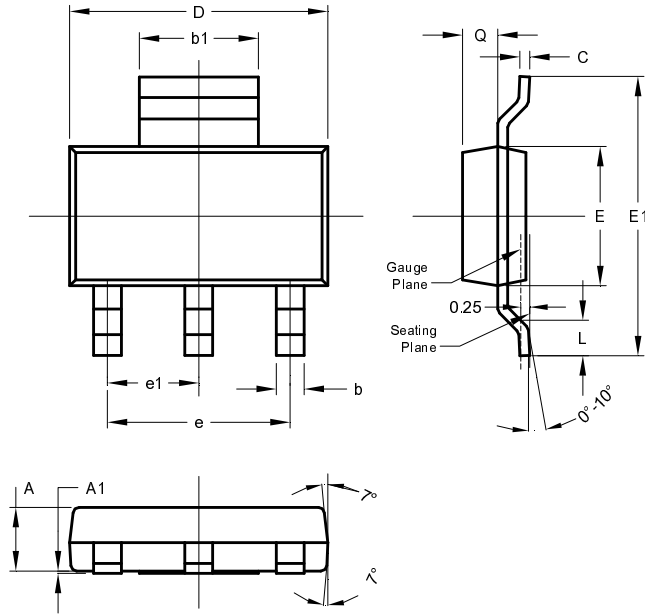
Switching Time Waveforms



Switching Time Test Circuit

Package Outline Dimensions

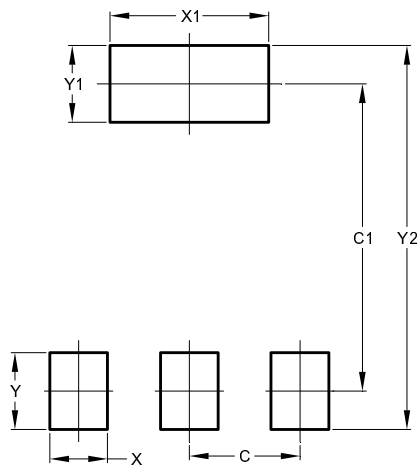
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.



SOT223			
Dim	Min	Max	Typ
A	1.55	1.65	1.60
A1	0.010	0.15	0.05
b	0.60	0.80	0.70
b1	2.90	3.10	3.00
C	0.20	0.30	0.25
D	6.45	6.55	6.50
E	3.45	3.55	3.50
E1	6.90	7.10	7.00
e	-	-	4.60
e1	-	-	2.30
L	0.85	1.05	0.95
Q	0.84	0.94	0.89
All Dimensions in mm			

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
C	2.30
C1	6.40
X	1.20
X1	3.30
Y	1.60
Y1	1.60
Y2	8.00

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